## 502809830 05/15/2014

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MIN YOUNG HWANG	04/24/2014

### **RECEIVING PARTY DATA**

Name:	LG INNOTEK CO., LTD.
Street Address:	SEOUL SQUARE, 541
Internal Address:	NAMDAEMUNNO 5-GA, JUNG-GU
City:	SEOUL
State/Country:	REPUBLIC OF KOREA
Postal Code:	100-714

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14354058

### CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	SUN.LGI.654
NAME OF SUBMITTER:	JEFF LLOYD
SIGNATURE:	/JEFF LLOYD/
DATE SIGNED:	05/15/2014

**Total Attachments: 2** 

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PATENT 502809830 REEL: 032900 FRAME: 0838

#### ASSIGNMENT

WHEREAS, I, the undersigned, residing at the indicated addresses given below, respectively, have invented certain new and useful improvements in <u>APPARATUS AND METHOD FOR FAB</u>
<u>RICATING EPI WAFER AND EPI WAFER</u>, for which an application for United States Letters Patent was filed, as Serial No. 14/354,058 on April 24, 2014.

WHEREAS, LG INNOTEK CO., LTD., a corporation of the country of the Seoul Squar e, 541, Namdaemunno 5-ga, Jung-gu, Seoul, 100-714, Republic of Korea, is desirous of acquirin g the entire right, title, and interest in and to said invention and in and to any Letters Patent which may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in view of valuable consideration, receipt of which is hereby ackno wledged, I, the undersigned, have sold, assigned, and transferred, and by these presents do sell, as sign, and transfer, unto said LG INNOTEK CO., LTD., its successors and assigns, the full and exclusive right to the said invention in the United States and its territorial possessions and in all for reign countries and the entire right, title, and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, and extensions thereof.

I hereby authorize and request the Patent Office Officials in the United States and in any a nd all foreign countries to issue any and all of said Letters Patent, when granted, to LG INNOTE K CO., LTD., as the assignee of the entire right, title, and interest in and to the same, for the sole use and behoof of said LG INNOTEK CO., LTD., its successors and assigns.

FURTHER, I agree that I will communicate to said LG INNOTEK CO., LTD., or its representatives, any facts known to me respecting said invention; testify in any legal proceedings; sign all lawful papers; execute all divisional, continuation, substitution, renewal, and reissue applications; execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said LG INNOTEK CO., LTD.,; make all rightful oaths; and generally do everything possible to aid the said LG INNOTEK CO., LTD., its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

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IN TESTIMONY WHEREOF, I have hereunto set my hand this \_\_\_\_day of

<u>Abrīl</u>, 2014.

SIWANG Min Van

Scoul Square, 541, Namdsemunno 5-ga, Jung-gu, Scoul, 100-714,

Republic of Korea

WITNESS

Signature:

Printed Name: KIM, Ji Hye

Date: April 24, 2014

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**RECORDED: 05/15/2014**